SURFACE MOUNT SILICON SCHOTTKY DIODE



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMHSH-3 is a silicon Schottky diode, epoxy molded in a SOD-123 surface mount package, designed for fast switching applications requiring a low forward voltage drop.

MARKING CODE: CH3



SOD-123 CASE

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	30	V
Continuous Forward Current	ΙF	200	mA
Peak Repetitive Forward Current	I _{FRM}	300	mA
Peak Forward Surge Current, tp<1.0s	I _{FSM}	600	mA
Power Dissipation	P_{D}	400	mW
Operating and Storage Junction Temperature	T _{J,} T _{stg}	-65 to +150	°C
Thermal Resistance	$\Theta_{\sf JA}$	312.5	°C/W

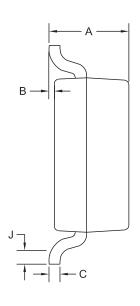
ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

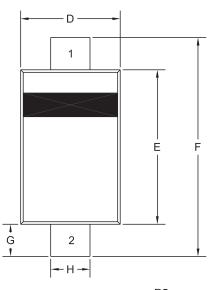
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_{R}	V _R =25V			2.0	μΑ
BV_R	I _R =100μA	30			V
VF	I _F =100μA			240	mV
VF	I _F =1.0mA			320	mV
VF	I _F =10mA			400	mV
V_{F}	I _F =30mA			500	mV
VF	I _F =100mA			1.0	V
CJ	V _R =1.0V, f=1.0MHz		7.0		pF
t _{rr}	$I_F = I_R = 10$ mA, $I_{rr} = 1.0$ mA, $R_L = 100$ Ω		7.0		ns

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SOD-123 CASE - MECHANICAL OUTLINE





R5

LEAD CODE1) Cathode

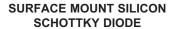
- 2) Anode

MARKING CODE: CH3

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.037	0.053	0.95	1.35			
В	0.000	0.005	0.00	0.12			
С	-	0.008	-	0.20			
D	0.055	0.071	1.40	1.80			
Е	0.098	0.110	2.50	2.80			
F	0.142	0.154	3.60	3.90			
G	0.016	-	0.40	-			
Н	0.020	0.028	0.50	0.70			
J	0.010	-	0.25	-			

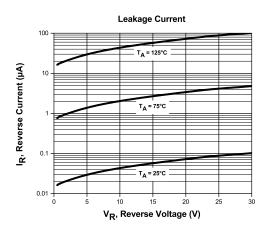
SOD-123 (REV:R5)

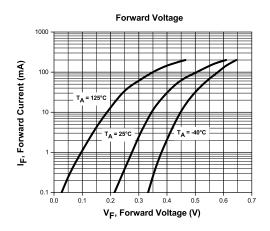
R7 (16-February 2016)

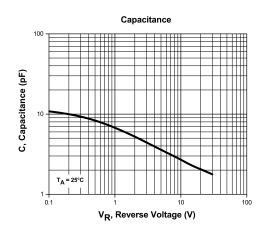


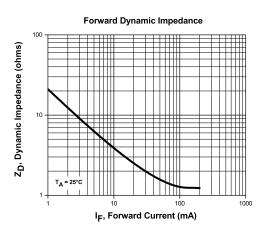


TYPICAL ELECTRICAL CHARACTERISTICS





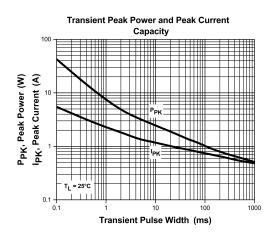


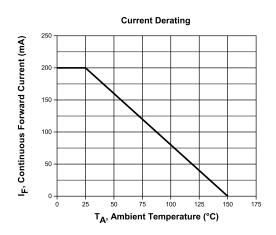


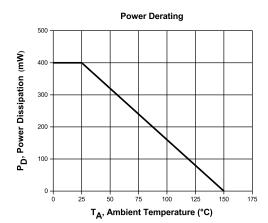
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TYPICAL ELECTRICAL CHARACTERISTICS







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- · Up-screening capabilities

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- · PbSn plating options
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- · Application notes
- · Application and design sample kits
- · Custom product and package development

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